2.5 V/3.3 V 16-bit edge-triggered D-type flip-flop; 3-state Rev. 5 — 9 July 2012 Product dat

Product data sheet

#### **General description** 1.

The 74ALVCH16374 is 16-bit edge-triggered flip-flop featuring separate D-type inputs for each flip-flop and 3-state outputs for bus oriented applications.

Incorporates bus hold data inputs which eliminate the need for external pull-up or pull-down resistors to hold unused inputs.

The 74ALVCH16374 consists of 2 sections of eight edge-triggered flip-flops. A clock (CP) input and an output enable  $(\overline{OE})$  are provided per 8-bit section.

The flip-flops will store the state of their individual D-inputs that meet the set-up and hold time requirements on the LOW-to-HIGH CP transition.

When  $\overline{OE}$  is LOW, the contents of the flip-flops are available at the outputs. When  $\overline{OE}$  is HIGH, the outputs go the high-impedance OFF-state. Operation of the OE input does not affect the state of the flip-flops.

#### 2. **Features and benefits**

- Wide supply voltage range from 1.2 V to 3.6 V
- Complies with JEDEC standard JESD8-B
- CMOS low power consumption
- MULTIBYTE flow-through standard pin-out architecture
- Low inductance multiple V<sub>CC</sub> and GND pins for minimum noise and ground bounce
- Direct interface with TTL levels
- All data inputs have bus hold
- Output drive capability 50 Ω transmission lines at 85 °C
- Current drive ±24 mA at V<sub>CC</sub> = 3.0 V

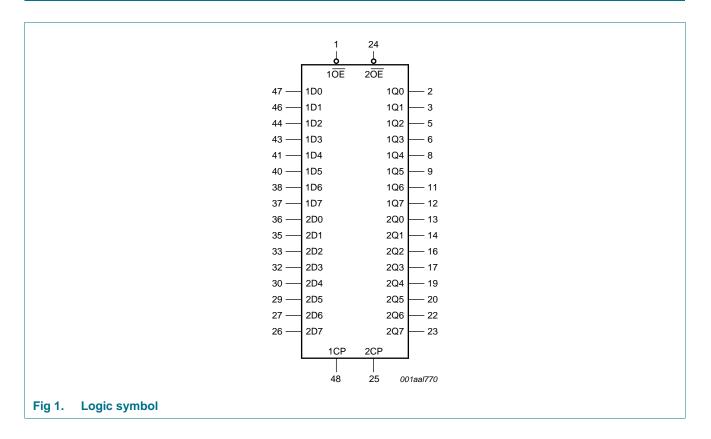


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# 3. Ordering information

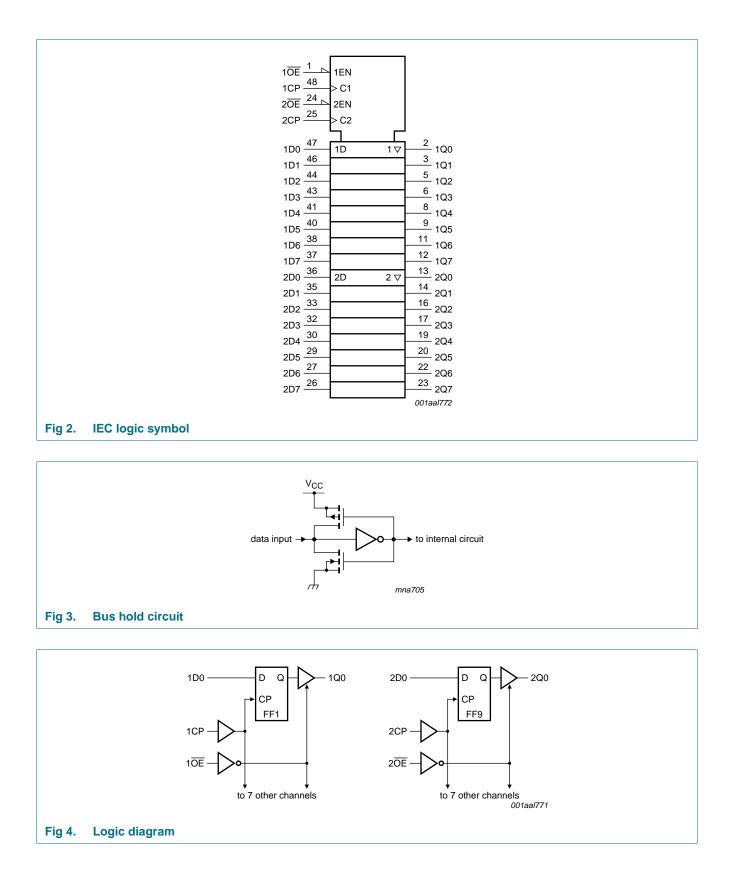
Table 1.OrderingType number	Information Temperature range	Package		
		Name	Description	Version
74ALVCH16374DL	–40 °C to +85 °C	SSOP48	plastic shrink small outline package; 48 leads; body width 7.5 mm	SOT370-1
74LVCH16374DGG	–40 °C to +85 °C	TSSOP48	plastic thin shrink small outline package; 48 leads; body width 6.1 mm	SOT362-1

# 4. Functional diagram



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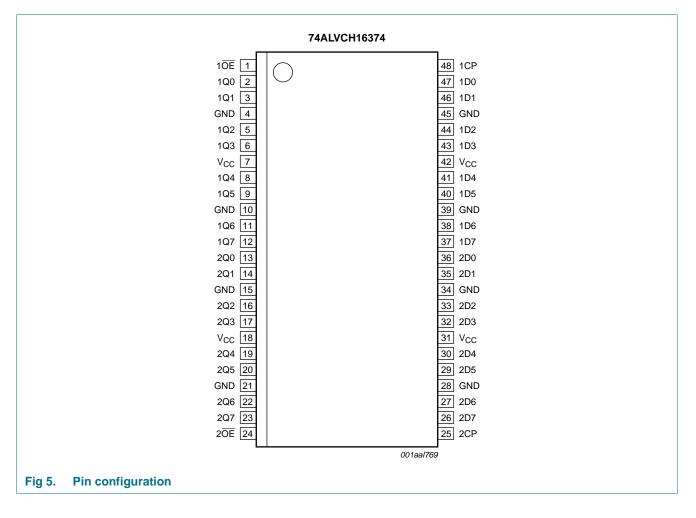
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# 5. Pinning information

### 5.1 Pinning



#### 2.5 V/3.3 V 16-bit edge-triggered D-type flip-flop; 3-state

## 5.2 Pin description

Table 2. Pin de	escription	
Symbol	Pin	Description
$1\overline{OE}, 2\overline{OE}$	1, 24	output enable input (active LOW)
1Q0 to 1Q7	2, 3, 5, 6, 8, 9, 11, 12	3-state flip-flop outputs
2Q0 to 2Q7	13, 14, 16, 17, 19, 20, 22, 23	3-state flip-flop outputs
GND	4, 10, 15, 21, 28, 34, 39, 45	ground (0 V)
V <sub>CC</sub>	7, 18, 31, 42	positive supply voltage
1D0 to 1D7	47, 46, 44, 43, 41, 40, 38, 37	data inputs
2D0 to 2D7	36, 35, 33, 32, 30, 29, 27, 26	data inputs
1CP, 2CP	48, 25	clock input

# 6. Functional description

### 6.1 Function table

#### Table 3. Function table<sup>[1]</sup>

Inputs			Internal	Outputs Q0 to Q7	Operating mode
nOE	nCP	Dn	flip-flops		
L	1	I	L	L	load and read register
L	1	h	Н	Н	
Н	1	I	L	Z	load register and disable outputs
Н	1	h	Н	Z	

[1] H = HIGH voltage level;

L = LOW voltage level;

h = HIGH voltage level one set-up time prior to the LOW-to-HIGH clock transition;

I = LOW voltage level one set-up time prior to the LOW-to-HIGH clock transition;

 $\uparrow$  = LOW-to-HIGH clock transition;

Z = high-impedance OFF-state.

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# 7. Limiting values

#### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+4.6	V
I <sub>IK</sub>	input clamping current	V <sub>1</sub> < 0 V	-50	-	mA
VI	input voltage	control inputs	<u>[1]</u> –0.5	+4.6	V
		data inputs	<u>[1]</u> –0.5	V <sub>CC</sub> + 0.5	V
I <sub>OK</sub>	output clamping current	$V_{O} > V_{CC}$ or $V_{O} < 0 V$	-	±50	mA
Vo	output voltage		<u>[1]</u> –0.5	V <sub>CC</sub> + 0.5	V
lo	output current	$V_{O} = 0 V$ to $V_{CC}$	-	±50	mA
I <sub>CC</sub>	supply current		-	100	mA
I <sub>GND</sub>	ground current		-100	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb}$ = -40 °C to +125 °C;			
		SSOP48 package	[2] _	850	mW
		TSSOP48 package	[3] _	600	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] Above 55 °C the value of  $P_{tot}$  derates linearly with 11.3 mW/K.

[3] Above 55 °C the value of  $P_{tot}$  derates linearly with 8 mW/K.

# 8. Recommended operating conditions

#### Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>CC</sub>	supply voltage	maximum speed performance				
		C <sub>L</sub> = 30 pF	2.3	-	2.7	V
		C <sub>L</sub> = 50 pF	3.0	-	3.6	V
		low voltage applications	1.2	-	3.6	V
VI	input voltage	data inputs	0	-	$V_{CC}$	V
		control inputs	0	-	5.5	V
Vo	output voltage		0	-	V <sub>CC</sub>	V
T <sub>amb</sub>	ambient temperature	in free air	-40	-	+85	°C
$\Delta t / \Delta V$	input transition rise and fall rate	$V_{CC}$ = 2.3 V to 3.0 V	0	-	20	ns/V
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	0	-	10	ns/V
-						

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# 9. Static characteristics

#### Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ <mark>[1]</mark>	Max	Unit
T <sub>amb</sub> = -4	10 °C to +85 °C					
V <sub>IH</sub>	HIGH-level input	V <sub>CC</sub> = 1.2 V	V <sub>CC</sub>	-	-	V
	voltage	V <sub>CC</sub> = 1.8 V	$0.7V_{CC}$	0.9	-	V
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.7	1.2	-	V
		$V_{CC} = 2.7 \text{ V} \text{ to } 3.6 \text{ V}$	2.0	1.5	-	V
V <sub>IL</sub>	LOW-level input	V <sub>CC</sub> = 1.2 V	-	-	0	V
	voltage	V <sub>CC</sub> = 1.8 V	-	0.9	$0.2V_{CC}$	V
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	-	1.2	0.7	V
		$V_{CC} = 2.7 V \text{ to } 3.6 V$	-	1.5	0.8	V
V <sub>OH</sub>	HIGH-level output	$V_{I} = V_{IH} \text{ or } V_{IL}$				
	voltage	$I_{O} = -100 \ \mu\text{A}; \ V_{CC} = 1.8 \ V \ to \ 3.6 \ V$	$V_{CC}-0.2$	V <sub>CC</sub>	-	V
		$I_{O} = -6 \text{ mA}; V_{CC} = 1.8 \text{ V}$	$V_{CC}-0.4$	$V_{CC}-0.1$	-	V
		$I_{O} = -6 \text{ mA}; V_{CC} = 2.3 \text{ V}$	$V_{CC}-0.3$	$V_{CC}-0.08$	-	V
		$I_0 = -12 \text{ mA}; V_{CC} = 2.3 \text{ V}$	$V_{CC} - 0.5$	$V_{CC}-0.17$	-	V
		$I_0 = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	$V_{CC} - 0.5$	$V_{CC}-0.14$	-	V
		$I_{O} = -18 \text{ mA}; V_{CC} = 2.3 \text{ V}$	$V_{CC}-0.6$	$V_{CC}-0.26$	-	V
		$I_0 = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	$V_{CC} - 1.0$	$V_{CC}-0.28$	-	V
V <sub>OL</sub>	LOW-level output	$V_{I} = V_{IH} \text{ or } V_{IL}$				
	voltage	$I_0 = 100 \ \mu\text{A}; \ V_{CC} = 1.8 \ V \ to \ 3.6 \ V$	-	0	0.20	V
		$I_0 = 6 \text{ mA}; V_{CC} = 1.8 \text{ V}$	-	0.09	0.30	V
		$I_0 = 6 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	0.07	0.20	V
		$I_0 = 12 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	0.15	0.40	V
		$I_0 = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	0.14	0.40	V
		$I_0 = 18 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	0.23	0.60	V
		$I_0 = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	0.27	0.55	V
I <sub>I</sub>	input leakage current	V <sub>CC</sub> = 1.8 V to 3.6 V				
		control input; $V_1 = 5.5$ V or GND	-	0.1	5	μA
		data input; $V_I = V_{CC}$ or GND	-	0.1	5	μA
I <sub>OZ</sub>	OFF-state output	$V_I = V_{IH} \text{ or } V_{IL}; V_O = V_{CC} \text{ or } GND$				
	current	$V_{CC}$ = 1.8 V to 2.7 V	-	0.1	5	μA
		$V_{CC} = 2.7 V \text{ to } 3.6 V$	-	0.1	10	μA
I <sub>LIZ</sub>	OFF-state input	$V_{I} = V_{CC}$ or GND				
	leakage current	$V_{CC} = 1.8 \text{ V to } 2.7 \text{ V}$	-	0.1	10	μΑ
		V <sub>CC</sub> = 3.6 V	-	0.1	15	μA
I <sub>CC</sub>	supply current	$V_{I} = V_{CC}$ or GND; $I_{O} = 0$ A;				
		$V_{CC} = 1.8 \text{ V to } 2.7 \text{ V}$	-	0.1	20	μA
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	-	0.2	40	μA

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Symbol	Parameter	Conditions		Min	Typ <mark>[1]</mark>	Мах	Unit
Δl <sub>CC</sub>	additional supply current	$V_{I}$ = $V_{CC}$ – 0.6 V; $I_{O}$ = 0 A; $V_{CC}$ = 2.7 V to 3.6 V					
		per control input		-	5	500	μA
		per data I/O input		-	150	750	μA
I <sub>BHL</sub>	bus hold LOW current	$V_{CC} = 2.3 \text{ V}; \text{ V}_{I} = 0.7 \text{ V}$	[2]	45	-	-	μΑ
		$V_{CC} = 3.0 \text{ V}; \text{ V}_{I} = 0.8 \text{ V}$	[2]	75	150	-	μΑ
I <sub>BHH</sub>	bus hold HIGH current	$V_{CC} = 2.3 \text{ V}; \text{ V}_{I} = 1.7 \text{ V}$	[2]	-45	-	-	μΑ
		$V_{CC} = 3.0 \text{ V}; \text{ V}_{I} = 2.0 \text{ V}$	[2]	-75	-175	-	μΑ
I <sub>BHLO</sub>	bus hold LOW	$V_{CC} = 2.7 V$	[2]	300	-	-	μA
	overdrive current	V <sub>CC</sub> = 3.6 V	[2]	450	-	-	μA
I <sub>BHHO</sub>	bus hold HIGH	$V_{CC} = 2.7 V$	[2]	-300	-	-	μA
	overdrive current	V <sub>CC</sub> = 3.6 V	[2]	-450	-	-	μA
CI	input capacitance			-	5.0	-	pF

#### Table 6. Static characteristics ...continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

[1] All typical values are measured at  $T_{amb} = 25 \text{ °C}$ .

[2] Valid for data inputs of bus hold parts only.

# **10.** Dynamic characteristics

#### Table 7. Dynamic characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V); test circuit Figure 9.

Symbol	Parameter	Conditions		Min	Typ <mark>[1]</mark>	Max	Unit
$T_{amb} = -40$	0 °C to +85 °C						
f <sub>max</sub>	maximum frequency	see <u>Figure 6</u>					
		V <sub>CC</sub> = 1.8 V		125	250	-	MHz
		$V_{CC}$ = 2.3 V to 2.7 V	[2]	150	300	-	MHz
		$V_{CC} = 2.7 V$		150	300	-	MHz
		$V_{CC}$ = 3.0 V to 3.6 V	<u>[3]</u>	200	350	-	MHz
t <sub>pd</sub>	propagation delay	nCP to nQn; see Figure 6	[4]				
		V <sub>CC</sub> = 1.2 V		-	7.7	-	ns
		V <sub>CC</sub> = 1.8 V		1.5	3.6	6.5	ns
		$V_{CC}$ = 2.3 V to 2.7 V	[2]	1.0	2.3	4.3	ns
		$V_{CC} = 2.7 V$		1.0	2.3	3.8	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	<u>[3]</u>	1.0	2.4	3.4	ns
t <sub>en</sub>	enable time	nOE to nQn; see Figure 7	<u>[4]</u>				
		V <sub>CC</sub> = 1.2 V		-	8.7	-	ns
		V <sub>CC</sub> = 1.8 V		1.5	4.0	7.2	ns
		$V_{CC}$ = 2.3 V to 2.7 V	[2]	1.0	2.6	4.8	ns
		$V_{CC} = 2.7 V$		1.0	2.9	4.8	ns
		$V_{CC}$ = 3.0 V to 3.6 V	[3]	1.0	2.3	4.0	ns

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#### 2.5 V/3.3 V 16-bit edge-triggered D-type flip-flop; 3-state

Symbol	Parameter	Conditions		Min	Typ <mark>[1]</mark>	Мах	Unit
t <sub>dis</sub>	disable time	nOE to nQn; see <u>Figure 7</u>	<u>[4]</u>				
		$V_{CC} = 1.2 V$		-	6.2	-	ns
		$V_{CC} = 1.8 V$		1.5	3.1	5.4	ns
		$V_{CC}$ = 2.3 V to 2.7 V	[2]	1.0	2.1	4.0	ns
		$V_{CC} = 2.7 V$		1.0	2.9	4.5	ns
		$V_{CC}$ = 3.0 V to 3.6 V	[3]	1.0	2.6	4.1	ns
t <sub>W</sub>	pulse width	nCP HIGH or LOW; see Figure 6					
		V <sub>CC</sub> = 1.8 V		4.0	2.0	-	ns
		$V_{CC}$ = 2.3 V to 2.7 V	[2]	3.0	1.6	-	ns
		$V_{CC} = 2.7 V$		3.0	1.6	-	ns
		$V_{CC}$ = 3.0 V to 3.6 V	[3]	2.5	1.4	-	ns
t <sub>su</sub>	set-up time	Dn to nCP; see Figure 8					
		V <sub>CC</sub> = 1.8 V		1.5	0.2	-	ns
		$V_{CC}$ = 2.3 V to 2.7 V	[2]	1.2	0.2	-	ns
		$V_{CC} = 2.7 V$		1.5	0.4	-	ns
		$V_{CC}$ = 3.0 V to 3.6 V	[3]	1.2	0.2	-	ns
t <sub>h</sub>	hold time	Dn to nCP; see Figure 8					
		V <sub>CC</sub> = 1.8 V		0.6	-0.2	-	ns
		$V_{CC}$ = 2.3 V to 2.7 V	[2]	0.8	-0.1	-	ns
		$V_{CC} = 2.7 V$		0.6	-0.2	-	ns
		$V_{CC}$ = 3.0 V to 3.6 V	<u>[3]</u>	0.8	0.0	-	ns
C <sub>PD</sub>	power dissipation	per flip-flop; $V_1 = GND$ to $V_{CC}$	<u>[5]</u>				
	capacitance	outputs enabled		-	16	-	pF
		outputs disabled		-	10	-	pF

#### Table 7. Dynamic characteristics ... continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V); test circuit Figure 9

[1] All typical values are measured at  $T_{amb}$  = 25 °C.

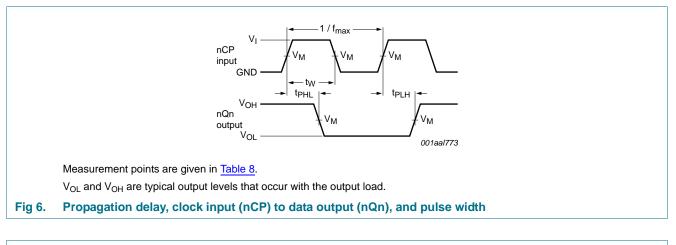
[2] Typical values are measured at V<sub>CC</sub> = 2.5 V.

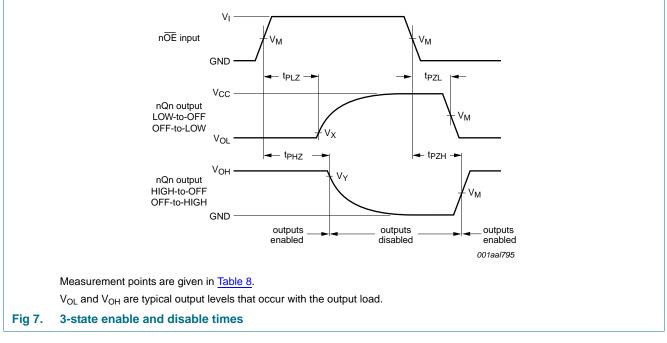
[3] Typical values are measured at  $V_{CC} = 3.3$  V.

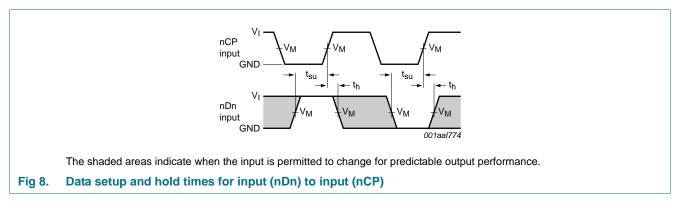
 $\Sigma(C_L \times V_{CC}^2 \times f_0) = \text{sum of the outputs.}$ 

### 2.5 V/3.3 V 16-bit edge-triggered D-type flip-flop; 3-state

# 11. Waveforms



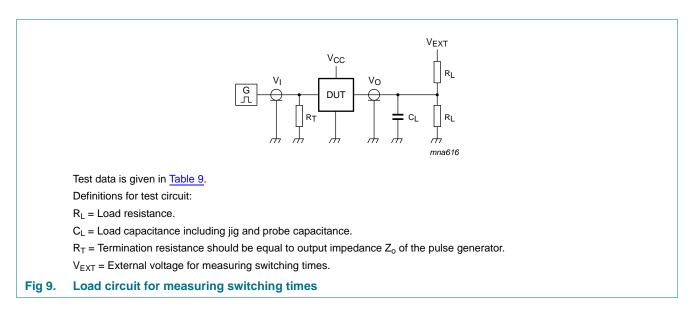




### 2.5 V/3.3 V 16-bit edge-triggered D-type flip-flop; 3-state

Table 8.         Measurement	points				
Supply voltage	Input		Output		
V <sub>cc</sub>	VI	V <sub>M</sub>	V <sub>M</sub>	V <sub>X</sub>	V <sub>Y</sub>
2.3 V to 2.7 V and < 2.3 V	V <sub>CC</sub>	$0.5\times V_{CC}$	$0.5  imes V_{CC}$	V <sub>OL</sub> + 0.15 V	$V_{OH} - 0.15 \ V$
2.7 V	2.7 V	1.5 V	1.5 V	V <sub>OL</sub> + 0.3 V	$V_{OH} - 0.3 \; V$
3.0 V to 3.6 V	2.7 V	1.5 V	1.5 V	V <sub>OL</sub> + 0.3 V	$V_{OH} - 0.3 \; V$

# **12. Test information**



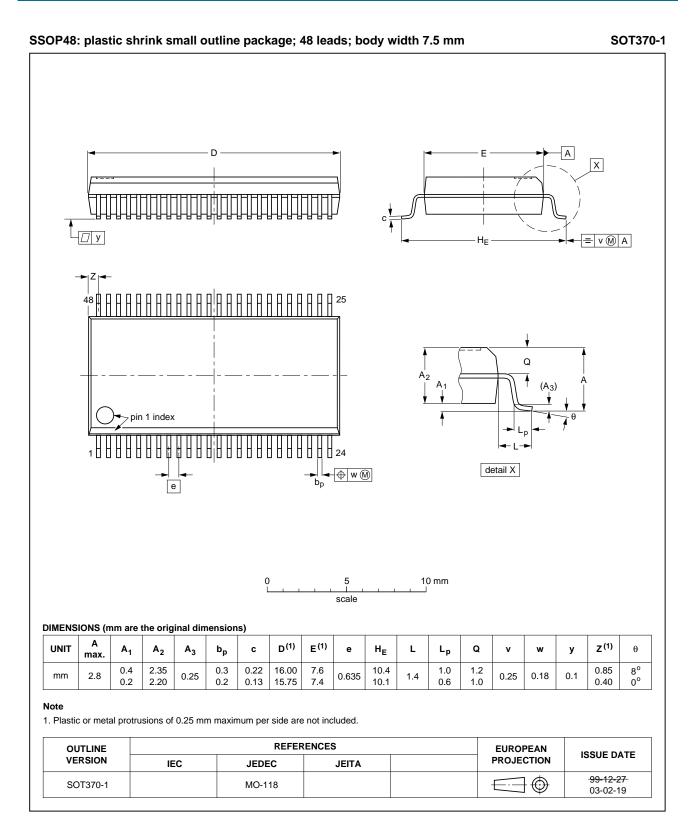
#### Table 9. Test data

Supply voltage	Input		Load		V <sub>EXT</sub>		
V <sub>cc</sub>	VI	t <sub>r</sub> , t <sub>f</sub>	CL	RL	t <sub>PLH</sub> , t <sub>PHL</sub>	t <sub>PLZ</sub> , t <sub>PZL</sub>	t <sub>PHZ</sub> , t <sub>PZH</sub>
2.3 V to 2.7 V and < 2.3 V	V <sub>CC</sub>	$\leq$ 2.0 ns	30 pF	500 Ω	open	$2 \times V_{CC}$	GND
2.7 V	2.7 V	2.5 ns	50 pF	500 Ω	open	$2\times V_{CC}$	GND
3.0 V to 3.6 V	2.7 V	2.5 ns	50 pF	500 Ω	open	$2\times V_{CC}$	GND

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# 13. Package outline



#### Fig 10. Package outline SOT370-1 (SSOP48)

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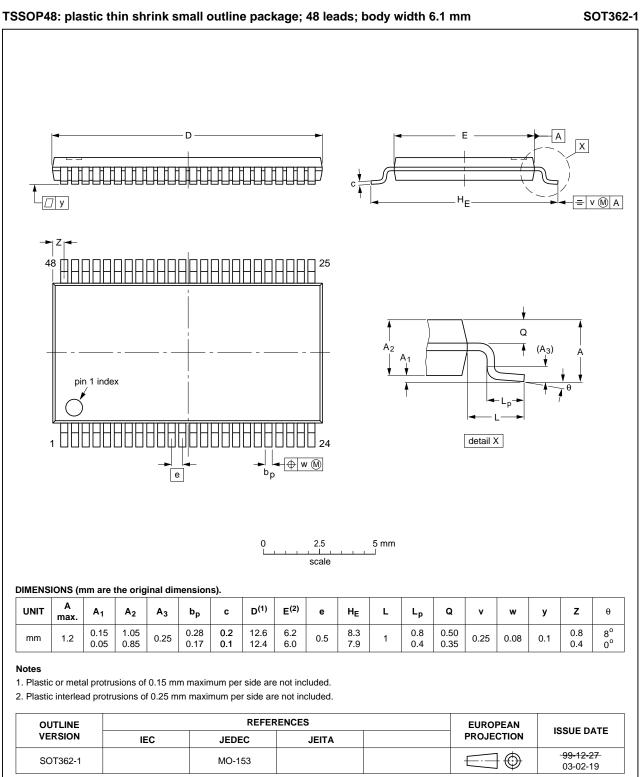


Fig 11. Package outline SOT362-1 (TSSOP48)
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2.5 V/3.3 V 16-bit edge-triggered D-type flip-flop; 3-state

# 14. Abbreviations

	Table 10. Abbreviations				
Acronym	Description				
CMOS	Complementary Metal-Oxide Semiconductor				
DUT	Device Under Test				
ESD	ElectroStatic Discharge				
HBM	Human Body Model				
MM	Machine Model				
TTL	Transistor-Transistor Logic				

# 15. Revision history

### Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74ALVCH16374 v.5	20120709	Product data sheet	-	74ALVCH16374 v.4
Modifications:	<ul> <li>Table 8 corre</li> </ul>	ected (errata).		
74ALVCH16374 v.4	20111117	Product data sheet	-	74ALVCH16374 v.3
Modifications:	<ul> <li>Legal pages updated.</li> </ul>			
74ALVCH16374 v.3	20100427	Product data sheet	-	74ALVCH16374 v.2
74ALVCH16374 v.2	19980618	Product specification	-	74ALVCH16374 v.1

# **16. Legal information**

#### 16.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <a href="http://www.nxp.com">http://www.nxp.com</a>.

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